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#### 3A ULTRA LOW DROPOUT LINEAR REGULATOR WITH ENABLE

## **Description**

The AP7175 is a 3.0A ultra low-dropout (LDO) linear regulator that features an enable input and a power-good output.

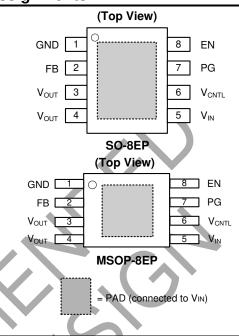
The enable input and power-good output allow users to configure power management solutions that can meet the sequencing requirements of FPGAs, DSPs, and other applications with different start-up and power-down requirements.

The AP7175 features two supply inputs, for power conversion supply and control. With the separation of the control and the power input very low dropout voltages can be reached and power dissipation is reduced.

A precision reference and feedback control deliver 1.5% accuracy over load, line, and operating temperature ranges.

The AP7175 is available in SO-8EP and MSOP-8EP package with an exposed PAD to reduce the junction to case resistance and extend the temperature range it can be used in.

## **Pin Assignments**



#### **Features**

- V<sub>IN</sub> Range: 1.2V to 3.65V V<sub>CNTL</sub> 3.0V to 5.5V
- Adjustable output voltage
- Continuous Output Current I<sub>OUT</sub> = 3A
- Fast transient response
- Power on reset monitoring on V<sub>CNTL</sub> and V<sub>IN</sub>
- Internal Softstart
- Stable with Low ESR MLCC Capacitors
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Applications**

- Notebook
- PQ
- Netbook
- Wireless Communication
- Server
- Motherboard
  - Dongle
- Front Side Bus VTT (1.2V/3.3A)

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## **Typical Applications Circuit**

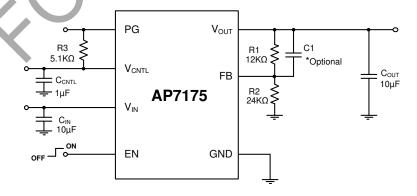


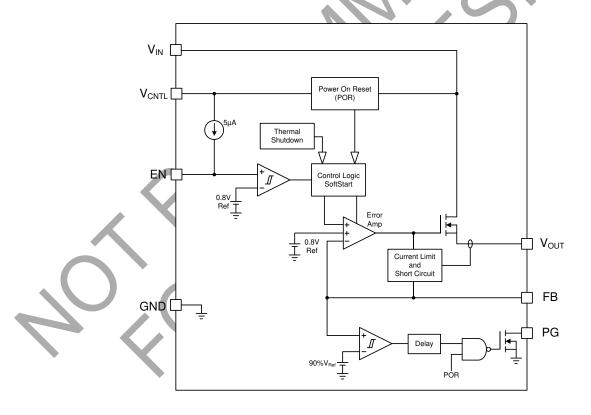
Figure 1. Typical Application Circuit



## **Pin Descriptions**

Pin	Pin Pin		Function	
Name	SO-8EP	MSOP-8EP	Function	
GND	1	1	Ground	
FB	2	2	Feedback to set the output voltage via an external resistor divider between V <sub>OUT</sub> and GND.	
V <sub>OUT</sub>	3/4	3/4	Power Output Pin. Connect at least 10μF capacitor to this pin to improve transient response and required for stability. When the part is disabled the output is discharged via an internal pull-low MOSFET.	
V <sub>IN</sub>	5	5	Power Input Pin for current supply. Connect a decoupling capacitor (≥10µF) as close as possible to the pin for noise filtering.	
V <sub>CNTL</sub>	6	6	BIAS supply for the controller, recommended 5V. Connect a decoupling capacitor ( $\geq 1\mu F$ ) as closes possible to the pin for noise filtering.	
PG	7	7	Power Good output open drain to indicate the status of $V_{OUT}$ via monitoring the FB pin. This pin is pulled low when the voltage is outside the limits, during thermal shutdown and if either $V_{CNTL}$ or $V_{IN}$ go below their thresholds.	
EN	8	8	Enable pin. Driving this pin low will disable the part. When left floating an internal current source will pull this pin high and enable it.	
PAD	EP	EP	Exposed pad connect this to V <sub>IN</sub> for good thermal conductivity.	

## **Functional Block Diagram**





**AP7175** 

## Absolute Maximum Ratings (Note 4) (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
V <sub>IN</sub>	V <sub>IN</sub> Supply Voltage (V <sub>IN</sub> to GND)	-0.3 to +4.0	V
V <sub>CNTL</sub>	V <sub>CNTL</sub> Supply Voltage (V <sub>CNTL</sub> to GND)	-0.3 to +7.0	V
V <sub>OUT</sub>	V <sub>OUT</sub> to GND Voltage	-0.3 to V <sub>IN</sub> +0.3	V
_	PG to GND Voltage	-0.3 to +7.0	V
_	EN, FB to GND Voltage	-0.3 to V <sub>CNTL</sub> +0.3	V
Ъ	Power Dissipation (SO-8EP)	1.7	W
$P_D$	Power Dissipation (MSOP-8EP)	1.5	W
TJ	Maximum Junction Temperature	+150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
T <sub>SDR</sub>	Maximum Lead Soldering Temperature, 10 Seconds	+260	°C

Note:

## Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Param	neter	Min	Max	Unit
V <sub>CNTL</sub>	V <sub>CNTL</sub> Supply Voltage		3.0	5.5	V
V <sub>IN</sub>	V <sub>IN</sub> Supply Voltage		1.2	3.65	V
V <sub>OUT</sub>	V <sub>OUT</sub> Output Voltage (when V <sub>CNTL</sub> -V	/ouτ >1.9V)	0.8	V <sub>IN</sub> - V <sub>DROP</sub>	V
1	VOUT Output Current	Continuous Current	0	3	А
l <sub>OUT</sub>		Peak Current	0	4	
	V <sub>OUT</sub> Output Capacitance	I <sub>OUT</sub> = 3A at 25% nominal V <sub>OUT</sub>	8	1100	
Соит		I <sub>OUT</sub> = 2A at 25% nominal V <sub>OUT</sub>	8	1700	μF
		I <sub>OUT</sub> = 1A at 25% nominal V <sub>OUT</sub>	8	2400	
E <sub>SRCOUT</sub>	ESR of Vout Output Capacitor		0	200	mΩ
TA	Ambient Temperature		-40	+85	°C
TJ	Junction Temperature		-40	+125	°C

<sup>4.</sup> Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.



**AP7175** 

### **Electrical Characteristics**

 $(V_{CNTL} = 5V, V_{IN} = 1.8V, V_{OUT} = 1.2V \text{ and } T_A = -40 \text{ to } +85^{\circ}\text{C}, @T_A = +25^{\circ}\text{C}, unless otherwise specified.})$ 

Symbol   Parameter   Test Conditions   Test   Te								
North   Vent   Supply Current   EN = Vent   Iout = 0A	Symbol	Parameter	Test Conditions					
VCNTL   VCNTL   VCNTL   Supply Current at   Sundamon   EN = CNTL   Supply Current at   EN = GND   EN = GND   Supply Current at Shutdown   EN = GND   E	,	OUDDENT		Min	Тур	Max		
Iso			EN V I OA	<u> </u>	1.0	1 5	m A	
Shutdown	IVCNTL		EIN = V <sub>CNTL</sub> , I <sub>OUT</sub> =UA	_	1.0	1.5	IIIA	
POWER-ON-RESET (POR)	I <sub>SD</sub>		EN = GND	_	15	30	μΑ	
Pising Vont POR Threshold   Pising Vont POR Threshold   Pising Vont POR Hysteresis   Pising Vont Por	_	V <sub>IN</sub> Supply Current at Shutdown	$EN = GND, V_{IN}=3.65V$			1	μΑ	
Voltr   POR Hysteresis	POWER-0	ON-RESET (POR)						
Rising V <sub>N</sub> POR Threshold	_	Rising V <sub>CNTL</sub> POR Threshold	_	2.5	2.7	2.95	V	
No Port Nysteresis	_	V <sub>CNTL</sub> POR Hysteresis	_		0.4	_	V	
Output Voltage   FB = Vour	_	Rising V <sub>IN</sub> POR Threshold	_	0.8	0.9	1.0	V	
Page	_	V <sub>IN</sub> POR Hysteresis	_	1	0.5	_	V	
Output Voltage Accuracy	OUTPUT	· ·						
VREF         Load Regulation         Iour = 0.0 to 3A         − 0.06         0.25         %           Line Regulation         Iour = 0.0 to 3A         − 0.06         0.25         %           Vour Pull-low Resistance         Vour = 0.8V         − 10         − 100         nA           PORPOUT VOLTAGE         Voin-to-Vour Dropout Voltage (Note 5)         Voin-to-Vour Dropout Voltage (Note 5)         Voin-to-Vour Dropout Voltage (Note 5)         Voint- 1.8V (Note 5)         T_J = 40 to +125°C         − 0.26         0.31         − 0.26         0.23         0.28         − 0.26         0.31         − 0.26         0.31         − 0.26         0.23         0.28         − 0.26         0.31         − 0.26         0.23         0.28         − 0.26         0.31         − 0.26         0.31         − 0.26         0.23         0.28         − 0.26         0.23         0.28         − 0.26         0.23         0.28         − 0.26         0.31         − 0.26         0.31         − 0.26         0.23         0.28         − 0.26         0.31         − 0.26         0.23         0.28         − 0.26         0.31         − 0.26         0.23         0.28         − 0.26         − 0.26         0.28         − 0.26         − 0.26         − 0.26 </td <td></td> <td>Reference Voltage</td> <td>FB = V<sub>OUT</sub></td> <td></td> <td>0.8</td> <td></td> <td>V</td>		Reference Voltage	FB = V <sub>OUT</sub>		0.8		V	
Value   Load Regulation   Lout = 0.4 to 3.4		Output Voltage Accuracy		-1.5	A	+1.5	%	
Line Regulation   LouT = 10mA, VCNTL = 3.0, to 5.5 V   -0.15	VREE	Load Regulation		1-1	0.06	0.25	%	
Vour Pull-low Resistance   Vont = 3.3V, Ven = 0V, Vour > 0.8V	- 11121	Line Regulation		-0.15	_	+0.15	%/V	
Variable		V <sub>OUT</sub> Pull-low Resistance		7	10	_	Ω	
VDROP         Vonto-Vour Dropout Voltage (Note 5)         Vont = 5.0V, lour = 3.0V, lour = 1.8V         T <sub>J</sub> = -40 to +125°C         — 0.24         0.29 0.24         0.29 0.29         Vont = 0.00         Vout = 1.8V (Note 5)         T <sub>J</sub> = -40 to +125°C         — 0.24 0.29         0.24 0.29         Volum = 1.8V (Note 5)         T <sub>J</sub> = -40 to +125°C         — 0.24 0.29         0.20 0.28         0.28         0.28         0.29         Volum = 1.2V (Note 5)         T <sub>J</sub> = -40 to +125°C         — 0.23 0.28         0.28         A <th< td=""><td></td><td>FB Input Current</td><td>V<sub>FB</sub> = 0.8V</td><td>-100</td><td>_</td><td>100</td><td>nA</td></th<>		FB Input Current	V <sub>FB</sub> = 0.8V	-100	_	100	nA	
VDROP         Vin-to-Vour Dropout Voltage (Note 5)         Vont = 5.0V, IOUT = 3A         Vout = 1.8V IOUT = 1.8V         T <sub>J</sub> = -40 to +125°C         — 0.24         0.29         V           I <sub>LIM</sub> Current-Limit Level         T <sub>J</sub> = -45°C, Vour = 80% VNoMINAL         4.5         5.7         6.7         A           PROTECTIONS         I <sub>SHORT</sub> Short Current-Limit Level         V <sub>FB</sub> < 0.2V	DROPOU	T VOLTAGE			•			
VDROP         Vin-to-Vout Dropout Voltage (Note 5)         Vont = 5.0V, lour = 3.0         Vont = 1.8V lour = 1.2V lour =			$T_{J} = +25^{\circ}C$	_	0.26	0.31		
Voron			$T_{\rm J} = -40 \text{ to } +125^{\circ}\text{C}$	_	_	0.42		
Indicates   Ind	Vonon	V <sub>IN</sub> -to-V <sub>OUT</sub> Dropout Voltage	101/12	_	0.24	0.29	V	
LILIM   Current-Limit Level   T_j = -40 to +125°C	V DROP	(Note 5)	$I_{OUT} = 3A$ $T_{J} = -40 \text{ to } +125^{\circ}\text{C}$	_	_	0.40	v	
T <sub>J</sub> = -40 to +125°C			Vour = 1 2V	_	0.23	0.28		
T <sub>J</sub> = -40 to +125°C			$I_{\rm J} = -40 \text{ to } +125^{\circ}\text{C}$	_	_			
T <sub>J</sub> = -40 to +125°C         4.2         —         —         A           PROTECTIONS           I <sub>SHORT</sub> Short Current-Limit Level         V <sub>FB</sub> < 0.2V	Lim	Current-Limit Level			5.7	6.7	Α	
Short Current-Limit Level   VFB < 0.2V			$T_{J} = -40 \text{ to } +125^{\circ}\text{C}$	4.2	_	_	Α	
T <sub>SD</sub> Thermal Shutdown Temperature         T <sub>J</sub> rising         —         +170         —         °C           —         Thermal Shutdown Hysteresis         —         +50         —         °C           ENABLE AND SOFT-START           —         EN Logic High Threshold Voltage         V <sub>EN</sub> rising         0.5         0.8         1.1         V           —         EN Hysteresis         —         0.1         —         V           —         EN Pull-High Current         EN = GND         —         5         —         μA           t <sub>SS</sub> Soft-Start Interval         —         0.3         0.6         1.2         ms           —         Turn On Delay         From being enabled to Vout rising 10%         200         350         500         μs           POWER-GOOD AND DELAY           V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         —         8         —         %           —         PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval				Π				
—         Thermal Shutdown Hysteresis         —         +50         —         °C           ENABLE AND SOFT-START           —         EN Logic High Threshold Voltage         V <sub>EN</sub> rising         0.5         0.8         1.1         V           —         EN Hysteresis         —         0.1         —         V           —         EN Pull-High Current         EN = GND         —         5         —         μA           t <sub>SS</sub> Soft-Start Interval         —         0.3         0.6         1.2         ms           —         Turn On Delay         From being enabled to VouT rising 10%         200         350         500         μs           POWER-GOOD AND DELAY           V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         8         —         %           —         PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval         V <sub>FB</sub> < falling PG voltage threshold				_		_		
ENABLE AND SOFT-START         —       EN Logic High Threshold Voltage       V <sub>EN</sub> rising       0.5       0.8       1.1       V         —       EN Hysteresis       —       0.1       —       V         —       EN Pull-High Current       EN = GND       —       5       —       μA         t <sub>SS</sub> Soft-Start Interval       —       0.3       0.6       1.2       ms         —       Turn On Delay       From being enabled to V <sub>OUT</sub> rising 10%       200       350       500       μs         POWER-GOOD AND DELAY         V <sub>THPG</sub> Rising PG Threshold Voltage       V <sub>FB</sub> rising       90       92       95       %         —       PG Threshold Hysteresis       —       —       8       —       %         —       PG Pull-low Voltage       PG sinks 5mA       —       0.25       0.4       V         —       PG Debounce Interval       V <sub>FB</sub> < falling PG voltage threshold	ISD		I J rising	_		_	_	
—         EN Logic High Threshold Voltage         V <sub>EN</sub> rising         0.5         0.8         1.1         V           —         EN Hysteresis         —         0.1         —         V           —         EN Pull-High Current         EN = GND         —         5         —         μA           t <sub>SS</sub> Soft-Start Interval         —         0.3         0.6         1.2         ms           —         Turn On Delay         From being enabled to V <sub>OUT</sub> rising 10%         200         350         500         μs           POWER-GOOD AND DELAY           V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         8         —         %           —         PG PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval         V <sub>FB</sub> < falling PG voltage threshold			F	_	+50	_	°C	
—         EN Hysteresis         —         0.1         —         V           EN Pull-High Current         EN = GND         —         5         —         μA           t <sub>SS</sub> Soft-Start Interval         —         0.3         0.6         1.2         ms           —         Turn On Delay         From being enabled to V <sub>OUT</sub> rising 10%         200         350         500         μs           POWER-GOOD AND DELAY           V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         8         —         %           —         PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval         V <sub>FB</sub> < falling PG voltage threshold	ENABLE		Ly	0.5				
—         EN Pull-High Current         EN = GND         —         5         —         μA           t <sub>SS</sub> Soft-Start Interval         —         0.3         0.6         1.2         ms           —         Turn On Delay         From being enabled to V <sub>OUT</sub> rising 10%         200         350         500         μs           POWER-GOOD AND DELAY           V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         8         —         %           —         PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval         V <sub>FB</sub> < falling PG voltage threshold	_		V <sub>EN</sub> rising	0.5		1.1		
t <sub>SS</sub> Soft-Start Interval         —         0.3         0.6         1.2         ms           —         Turn On Delay         From being enabled to V <sub>OUT</sub> rising 10%         200         350         500         μs           POWER-GOOD AND DELAY           V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         8         —         %           —         PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval         V <sub>FB</sub> < falling PG voltage threshold			EN - GND					
—         Turn On Delay         From being enabled to V <sub>OUT</sub> rising 10%         200         350         500         μs           POWER-GOOD AND DELAY           V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         8         —         %           —         PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval         V <sub>FB</sub> < falling PG voltage threshold	tec			0.3		12		
POWER-GOOD AND DELAY           V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         8         —         %           —         PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval         V <sub>FB</sub> < falling PG voltage threshold	- 35		From being enabled to Vour rising 10%					
V <sub>THPG</sub> Rising PG Threshold Voltage         V <sub>FB</sub> rising         90         92         95         %           —         PG Threshold Hysteresis         —         8         —         %           —         PG Pull-low Voltage         PG sinks 5mA         —         0.25         0.4         V           —         PG Debounce Interval         V <sub>FB</sub> < falling PG voltage threshold	POWER-0							
—     PG Pull-low Voltage     PG sinks 5mA     —     0.25     0.4     V       —     PG Debounce Interval     V <sub>FB</sub> < falling PG voltage threshold		·	V <sub>FB</sub> rising	90	92	95	%	
—     PG Debounce Interval     V <sub>FB</sub> < falling PG voltage threshold	_	PG Threshold Hysteresis	_	_	8	_	%	
	_	PG Pull-low Voltage	PG sinks 5mA	_	0.25	0.4	V	
— PG Delay Time From $V_{FB} = V_{THPG}$ to rising edge of the $V_{PG}$ 1 2 4 ms	_	PG Debounce Interval	V <sub>FB</sub> < falling PG voltage threshold	_	10	_	μs	
The state of the s	_	PG Delay Time	From V <sub>FB</sub> = V <sub>THPG</sub> to rising edge of the V <sub>PG</sub>	1	2	4	ms	

Note: 5. Dropout voltage is the voltage difference between the inut and the output at which the output voltage drops 2% below its nominal value.



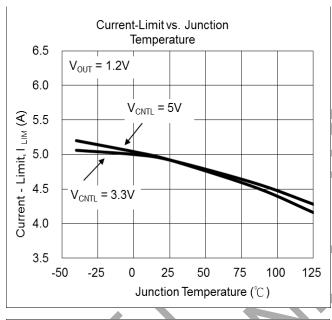
#### **Electrical Characteristics** (Cont.)

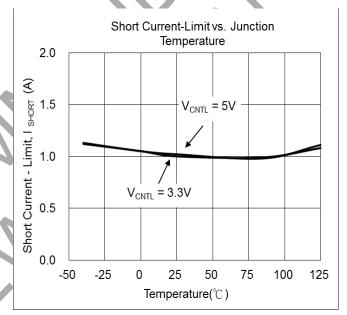
 $(V_{CNTL} = 5V, V_{IN} = 1.8V, V_{OUT} = 1.2V \text{ and } T_A = -40 \text{ to } +85^{\circ}\text{C}, @T_A = +25^{\circ}\text{C}, unless otherwise specified.})$ 

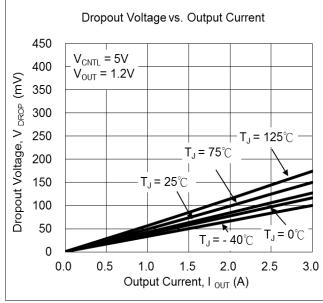
Symbol	Parameter	Test Conditions	AP7175			Unit
Syllibol	Farameter		Min	Тур	Max	Offic
THERMA	L CHARACTERISTIC					
Δ	θ <sub>JA</sub> Thermal Resistance Junction-to-Ambient	SO-8EP (Note 6)	_	70		°C/W
ОЈА		MSOP-8EP (Note 7)	_	80		°C/W
θ <sub>JC</sub> Thermal Resistance Jur	Thormal Posistance Junction to Case	SO-8EP (Note 6)	_	30		°C/W
	mermai nesistance junction-to-case	MSOP-8EP (Note 7)		30	_	°C/W

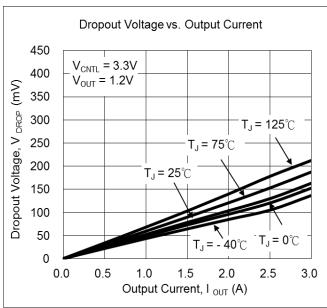
Notes:

## **Typical Characteristics**





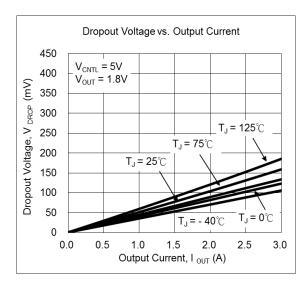


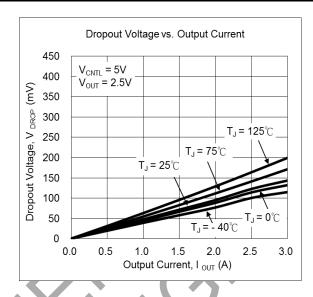


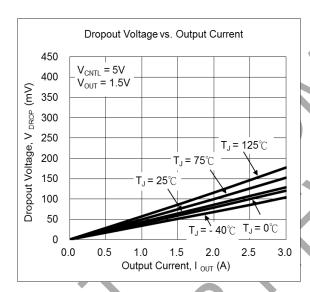
<sup>6.</sup> Device mounted on 2"\*2" FR-4 substrate PC board, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground plane.
7. Device mounted on 2"\*2" FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

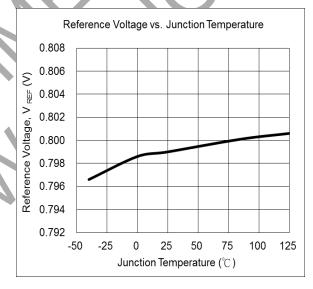


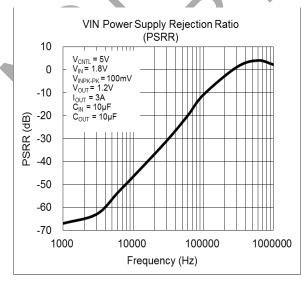
## Typical Characteristics (Cont.)

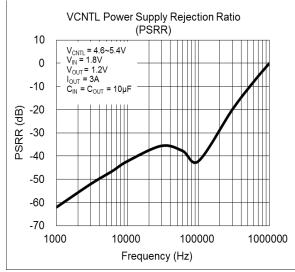






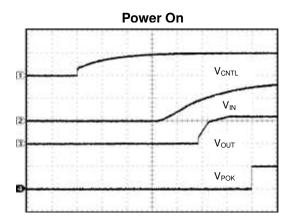




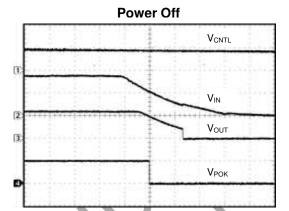




## $\textbf{Operating Waveforms} \ ( @ \ V_{CNTL} = 5V, \ V_{IN} = 1.8V, \ V_{OUT} = 1.2V, \ T_A = +25^{\circ}C, \ unless \ otherwise \ specified. )$



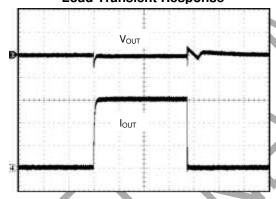
 $\begin{array}{l} C_{OUT} \! \! = \! 10 \mu F, \, C_{IN} \! \! = \! 10 \mu F, \, R_L \! \! = \! 0.4 \Omega \\ CH1: \, V_{CNTL}, \, 5 V/Div, \, DC \\ CH2: \, V_{IN}, \, 1 V/Div, \, DC \\ CH3: \, V_{OUT}, \, 1 V/Div, \, DC \\ CH4: \, V_{POK}, \, 5 V/Div, \, DC \\ \end{array}$ TIME: 2ms/Div



 $C_{OUT}{=}10\mu F,\,C_{IN}{=}10\mu F,\,R_L{=}0.4\Omega$ 

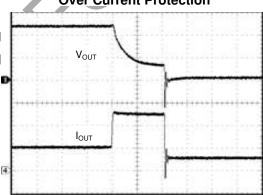
CH1: V<sub>CNTL</sub>, 5V/Div, DC CH2: V<sub>IN</sub>, 1V/Div, DC CH3: V<sub>OUT</sub>, 1V/Div, DC CH4: V<sub>POK</sub>, 5V/Div, DC TIME: 2ms/Div

#### **Load Transient Response**



 $l_{OUT}$  = 10mA to 3A to10mA (rise / fall time =1µs)  $C_{OUT}$  = 10µF,  $C_{IN}$  = 10µF CH1:  $V_{OUT}$ , 50mV/Div, AC CH2: I<sub>OUT</sub>, 1A/Div, DC TIME: 50µs/Div

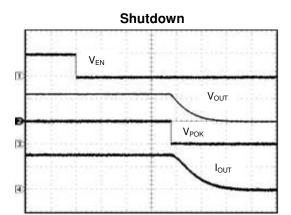
## **Over Current Protection**



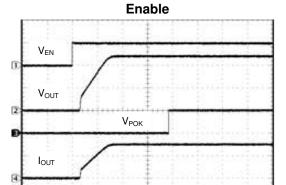
 $C_{OUT}$  = 10 µF,  $C_{IN}$  = 10 µF,  $I_{OUT}$  = 2A to 5.6A CH1: V\_{OUT}, 0.5V/Div, DC CH2:  $I_{OUT},$  2A/Div, DC TIME: 0.2ms/Div



## $\textbf{Operating Waveforms} \ \, \text{(Cont.)} \ \, \text{(@ $V_{CNTL} = 5V$, $V_{IN} = 1.8V$, $V_{OUT} = 1.2V$, $T_{A} = +25^{\circ}C$, unless otherwise specified.)}$



$$\begin{split} &C_{OUT} = 10 \mu F, \ C_{IN} = 10 \mu F, \ R_L = 0.4 \Omega \\ &CH1: \ V_{EN}, \ 5 V/Div, \ DC \\ &CH2: \ V_{OUT}, \ 1 V/Div, \ DC \\ &CH3: \ V_{POK}, \ 5 V/Div, \ DC \\ &CH4: \ I_{OUT}, \ 2 A/Div, \ DC \\ &TIME: \ 4 \mu s/Div \end{split}$$



$$\begin{split} &C_{OUT} = 10 \mu F, \, C_{IN} = 10 \mu F, \, R_L = 0.4 \Omega \\ &CH1: \, V_{EN}, \, 5V/Div, \, DC \\ &CH2: \, V_{OUT}, \, 1V/Div, \, DC \\ &CH3: \, V_{POK}, \, 5V/Div, \, DC \\ &CH4: \, I_{OUT}, \, 2A/Div, \, DC \\ &TIME: \, 1ms/Div \end{split}$$



**AP7175** 

## **Application Information**

#### **Power Good and Delay**

AP7175 monitors the feedback voltage  $V_{FB}$  on the FB pin. An internal delay timer is started after the PG voltage threshold ( $V_{THPG}$ ) on the FB pin is reached. At the end of the delay time an internal NMOS of the PG is turned off to indicate that the power at the output is good (PG). This monitoring function is continued during operation and if  $V_{FB}$  falls 8% (typ) below  $V_{THPG}$ , the NMOS of the PG is turned on after a delay time of typical 10µs to avoid oscillating of the PG signal.

#### **Power On Reset**

AP7175 monitors both supply voltages,  $V_{CNTL}$  and  $V_{IN}$  to ensure operation as intended. A Soft-Start process is initiated after both voltages exceed their POR threshold during power on. During operation the POR component continues to monitor the supply voltage and pulls the PG low to indicate an out of regulation supply. This function will engage without regard to the status of the output.

#### Soft-Start

AP7175 incorporates an internal Soft-Start function. The output voltage rise is controlled to limit the current surge during start-up. The typical Soft-Start time is 0.6ms.

#### **Current-Limit Protection**

AP7175 monitors the current flow through the NMOS and limits the maximum current to avoid damage to the load and AP7175 during overload conditions.

#### **Short Circuit Current-Limit Protection**

AP7175 incorporates a current limit function to reduce the maximum current to 1.1A (typ) when the voltage at FB falls below 0.2V (typ) during an overload or short circuit situation.

During start-up period, this function is disabled to ensure successful heavy load start-up.

#### **Enable Control**

If the enable pin (EN) is left open, an internal current source of ~5µA pulls the pin up and enables the AP7175. This will reduce the bill of material saving an external pull up resistor. Driving the enable pin low disables the device. Driving the pin high subsequently initiates a new Soft-Start cycle.

#### **Output Voltage Regulation**

Output Voltage is set by resistor divider from  $V_{QUT}$  via FB pin to GND. Internally  $V_{FB}$  is compared to a 0.8V temperature compensated reference voltage and the NMOS pass element regulates the output voltage while delivering current from  $V_{IN}$  to  $V_{QUT}$ .

#### **Setting the Output Voltage**

A resistor divider connected to FB pin programs the output voltage.

$$V_{OUT} = V_{REF} * \left(1 + \frac{R1}{R2}\right) V$$

R1 is connected from V<sub>OUT</sub> to FB with Kelvin sensing connection. R2 is connected from FB to GND. To improve load transient response and stability, a bypass capacitor can be connected in parallel with R1. (optional in typical application circuit)

#### **Power Sequencing**

AP7175 requires no specific sequencing between  $V_{IN}$  and  $V_{CNTL}$ . However, care should be taken to avoid forcing  $V_{OUT}$  for prolonged time without the presence of  $V_{IN}$ . Conduction through internal parasitic diode (from  $V_{OUT}$  to  $V_{IN}$ ) could damage AP7175.

#### Thermal Shutdown

The PCB layout and power requirements for AP7175 under normal operation condition should allow enough cooling to restrict the junction temperature to +125°C. The packages for AP7175 have an exposed PAD to support this. These packages provide better connection to the PCB and thermal performance. Refer to the layout considerations.

If AP7175 junction temperature reaches +170°C a thermal protection block disables the NMOS pass element and lets the part cool down. After its junction temperature drops by 50°C (typ), a new Soft-Start cycle will be initiated. A new thermal protection will start, if the load or ambient conditions continue to raise the junction temperature to +170°C. This cycle will repeat until normal operation temperature is maintained again.



AP7175

### **Application Information (Cont.)**

#### **Output Capacitor**

An output capacitor ( $C_{OUT}$ ) is needed to improve transient response and maintain stability. The ESR (equivalent series resistance) and capacitance drives the selection. Care needs to be taken to cover the entire operating temperature range.

The output capacitor can be an Ultra-Low-ESR ceramic chip capacitor or a low ESR bulk capacitor like a solid tantalum, POSCap or aluminum electrolytic capacitor.

C<sub>OUT</sub> is used to improve the output stability and reduces the changes of the output voltage during load transitions. The slew rate of the current sensed via the FB pin in AP7175 is reduced. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors.

It is recommended to place ceramic capacitors as close as possible to the load and the ground pin and care should be taken to reduce the impedance in the layout.

#### **Input Capacitor**

To prevent the input voltage from dropping during load steps it is recommended to utilize an input capacitor  $(C_{IN})$ . As with the output capacitor the following are acceptable, Ultra-Low-ESR ceramic chip capacitor or low ESR bulk capacitor like a solid tantalum, POSCap or aluminum electrolytic capacitor. Typically it is recommended to utilize an capacitance of at least  $10\mu\text{F}$  to avoid output voltage drop due to reduced input voltage. The value can be lower if  $V_{IN}$  changes are not critical for the application.

#### **Layout Considerations**

For good ground loop and stability, the input and output capacitors should be located close to the input, output, and ground pins of the device. No other application circuit is connected within the loop. Avoid using vias within ground loop. If vias must be used, multiple vias should be used to reduce via inductance.

The regulator ground pin should be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance.

Wide trace should be used for large current paths from VIN to VOUT, and load circuit.

Place the R1, R2, and C1 (optional) near the LDO as close as possible to avoid noise coupling.

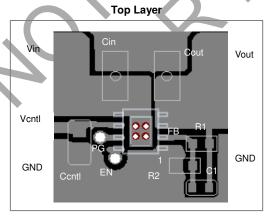
R2 is placed close to device ground. Connect the ground of the R2 to the GND pin by using a dedicated trace.

Connect the pin of the R1 directly to the load for Kelvin sensing.

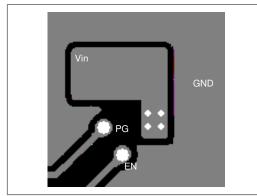
No high current should flow through the ground trace of feedback loop and affect reference voltage stability.

For the packages with exposed pads, heat sinking is accomplished using the heat spreading capability of the PCB and its copper traces. Suitable PCB area on the top layer and thermal vias(0.3mm drill size with 1mm spacing, 4~8 vias at least) to the Vin power plane can help to reduce device temperature greatly.

#### Reference Layout Plots

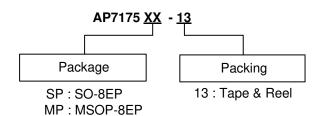


#### **Bottom Layer**





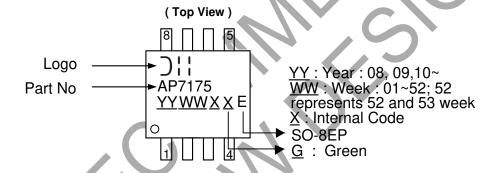
## **Ordering Information**



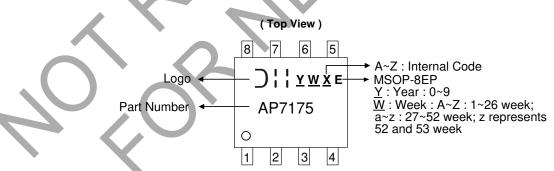
Part Number	Package Code	Dookoaina	13" Tape and Reel		
Part Number	Package Code	Packaging	Quantity	Part Number Suffix	
AP7175SP-13	SP	SO-8EP	2500/Tape & Reel	-13	
AP7175MP-13	MP	MSOP-8EP	2500/Tape & Reel	-13	

## **Marking Information**

### (1) SO-8EP



#### (2) MSOP-8EP

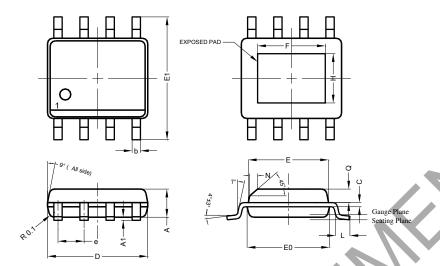




## **Package Outline Dimensions**

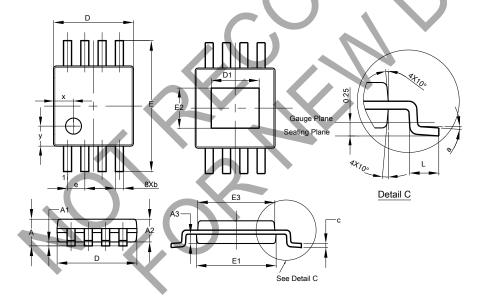
Please see http://www.diodes.com/package-outlines.html for the latest version.

#### (1) SO-8EP



SO-8EP					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
<b>A</b> 1	0.00	0.13	•		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
E1	5.90	6.10	6.00		
е	-	-	1.27		
F	2.75	3.35	3.05		
Н	2.11	2.71	2.41		
Ľ	0.62	0.82	0.72		
N		•	0.35		
Q	0.60	0.70	0.65		
All Di	All Dimensions in mm				

## (2) MSOP-8EP



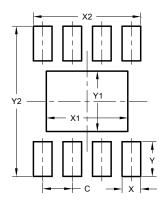
MSOP-8EP					
Dim	Min	Max	Тур		
Α	-	1.10	-		
<b>A</b> 1	0.05	0.15	0.10		
A2	0.75	0.95	0.86		
A3	0.29	0.49	0.39		
b	0.22	0.38	0.30		
С	0.08	0.23	0.15		
D	2.90	3.10	3.00		
D1	1.60	2.00	1.80		
Е	4.70	5.10	4.90		
E1	2.90	3.10	3.00		
E2	1.30	1.70	1.50		
E3	2.85	3.05	2.95		
е	-	-	0.65		
L	0.40	0.80	0.60		
а	0°	8°	4°		
Х	-	-	0.750		
у	-	-	0.750		
All Dimensions in mm					



## **Suggested Pad Layout**

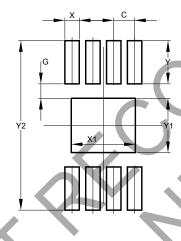
Please see http://www.diodes.com/package-outlines.html for the latest version.

## (1) SO-8EP



Dimensions	Value (in mm)
С	1.270
Х	0.802
X1	3.502
X2	4.612
Υ	1.505
Y1	2.613
Y2	6.500

#### (2) MSOP-8EP



Dimensions	Value (in mm)	
С	0.650	
G	0.450	
X	0.450	
X1	2.000	
Υ	1.350	
Y1	1.700	
Y2	5.300	



**AP7175** 

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